

In the Claims:

✓
Please cancel claims 37 and 40.

Please amend the claims as follows.

B16

9.
1. (Amended) A semiconductor device comprising:
at least one color filter over a substrate;
an adhesive layer over the substrate and the at least one color filter;
an insulating film over said adhesive layer;
at least one thin film transistor over the insulating film and the at least one color filter; and
at least one light emitting element over the at least one thin film transistor,
wherein light emitted from said ^{at least one} light emitting element is emitted through said substrate.

C

B17

11.
3. (Amended) A device according to claim ⁹ 1, wherein said semiconductor device further comprises driver circuits over said insulating film and the at least one color filter, and said driver circuits comprise thin film transistors.

¹²
~~4~~. (Amended) A device according to claim ⁹~~1~~, wherein the at least one color filter is provided on said substrate at a position aligned with the at least one thin film transistor.

*Cont
B17*
¹³
~~5~~. (Amended) A device according to claim ⁹~~1~~, wherein said insulating film covers said at least one color filter, and has a planarized surface.

¹⁴
~~6~~. (Amended) A device according to claim ⁹~~1~~, wherein at least one red color filter of said at least one color filter is provided at position aligned with at least channel forming region of said at least one thin film transistor.

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¹⁷
~~9~~. (Amended) A device according to claim ¹²~~4~~, further comprising a black mask together with said at least one color filter.

B19
1. ~~17~~. (Amended) A semiconductor device comprising:
at least one color filter provided over a substrate;
an adhesive layer over said substrate and said at least one color filter;
an insulating film on said adhesive layer; and
at least one thin film transistor over the insulating film and the at least one color filter; and

C at least one light emitting elements over said at least one thin film transistor.

Cont B19 2. 18. (Amended) A device according to claim 17, wherein said semiconductor device further comprises driver circuits over said insulating film and said at least one color filter, and said driver circuits comprise thin film transistors.

B20 4. 20. (Amended) A device according to claim 17, wherein at least one red color filter of said at least one color filter is provided at position aligned with at least channel forming region of said at least one thin film transistor.

B21 6. 22. (Amended) A device according to claim 17, wherein a fixing substrate is provided over said at least one thin film transistor so as to face said substrate.

B22 19. 29. (Amended) A semiconductor device comprising:
 at least one red color filter provided over a substrate;
 an adhesive layer over said substrate and said at least one red color filter;
 an insulating film on said adhesive layer; and
 at least one thin film transistor over the insulating film and said at least one red color filter; and

cont B22
at least one light emitting element over the at least one thin film transistor.

B23 23. ~~45~~¹⁹. (Amended) A device according to claim ~~39~~¹⁹, wherein a fixing substrate is provided over said at least one thin film transistor so as to face said substrate.

Please add the following new claims 47-57.

B24 25.
~~47~~. (New) A semiconductor device comprising:
at least one color filter over a substrate;
an adhesive layer over the substrate and the at least one color filter;
a first insulating film over said adhesive layer;
at least one thin film transistor over the first insulating film and the at least one color filter;
a second insulating film over said at least one thin film transistor; and
at least one light emitting element over the second insulating film.

29.
~~48~~. (New) A semiconductor device comprising:
at least one color filter over a substrate;

an adhesive layer over the substrate and the at least one color filter;

a first insulating film over said adhesive layer;

at least one thin film transistor over the first insulating film and the at least one color filter;

a second insulating film over said at least one thin film transistor;

at least one light emitting element over the second insulating film; and

a passivation film comprising nitride over the at least one light emitting element.

33.
49. (New) A semiconductor device comprising:

a first substrate comprising an organic material;

at least one color filter over the first substrate;

C an adhesive layer over the ^{first} substrate and the at least one color filter;

a first insulating film over said adhesive layer;

at least one thin film transistor over the first insulating film and the at least one color filter;

a second insulating film over said at least one thin film transistor;

at least one light emitting element over the second insulating film; and

a second substrate comprising an organic material over the at least one light emitting element.

*Cont
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^{26.}
~~50.~~ (New) A device according to claim ²⁵~~47~~, wherein the substrate comprises organic material.

^{30.}
~~51.~~ (New) A device according to claim ²⁹~~48~~, wherein the substrate comprises organic material.

^{27.}
~~52.~~ (New) A device according to claim ²⁵~~47~~, wherein said adhesive layer comprises a material selected from the group consisting of polyimide, acrylic, and epoxy resin.

^{31.}
~~53.~~ (New) A device according to claim ²⁹~~48~~, wherein said adhesive layer comprises a material selected from the group consisting of polyimide, acrylic, and epoxy resin.

^{34.}
~~54.~~ (New) A device according to claim ³³~~49~~, wherein said adhesive layer comprises a material selected from the group consisting of polyimide, acrylic, and epoxy resin.

^{28.}
~~55.~~ (New) A device according to claim ²⁵~~47~~, wherein said semiconductor device is selected from the group consisting of a video camera, a digital camera, a goggle type display, a car

navigation system, a personal computer, and a personal digital assistant.

32.

cont B24
~~56.~~ (New) A device according to claim ~~48~~²⁹, wherein said semiconductor device is selected from the group consisting of a video camera, a digital camera, a goggle type display, a car navigation system, a personal computer, and a personal digital assistant.

35.

~~57.~~ (New) A device according to claim ~~49~~³³, wherein said semiconductor device is selected from the group consisting of a video camera, a digital camera, a goggle type display, a car navigation system, a personal computer, and a personal digital assistant.
